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PAPER



Cite this: RSC Adv., 2021, 11, 34416

Eco-benign PVA/aluminum phosphate as an alternative to formaldehyde-based adhesives in wood-based panels†

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Aluminum phosphate (AP) shows great potential to replace formaldehyde-based adhesives in the wood industry, except for its weak hygroscopic resistance and low wet bonding strength. This study chose PVA as an AP modifier to prepare a PVA-AP organic-inorganic hybrid adhesive (PAP). The preparation, bonding mechanism and heat resistant property of PAP were studied by using X-ray photoelectron spectroscopy (XPS), Fourier transforms infrared spectroscopy (FTIR), X-ray diffraction (XRD), thermogravimetry-differential scanning calorimetry (TG-DSC), nuclear magnetic resonance (NMR) and scanning electron microscopy (SEM). The result showed that covalent bonds between PVA and AP were built. The mechanical properties of PAP improved remarkably; the dry and wet bonding strength are 2.28 and 0.79 MPa with 15.2% and 690% increment, respectively, compared to the control samples. The thermostabilities of PAP and plywood samples were improved. In conclusion, PVA could effectively improve the hygroscopic resistance and low wet bonding strength of AP adhesives.

Received 20th July 2021 Accepted 14th October 2021

DOI: 10.1039/d1ra05552f

rsc.li/rsc-advances

1. Introduction

Indoor air pollution from formaldehyde-based adhesives has attracted extensive attention because of their adverse health effects.¹ Nowadays, "green" or biomaterials are considered for the interior walls of buildings due to their environmental sustainability and carbon impact,²,³ Using wood and woodbased products is considered to be more sustainable compared to concretes and steels. Adhesives used in woodbased board manufacturing play a key role in determining the bond quality and mechanical strength.⁴ Aluminum phosphate (AP) materials have been used as binders for about 60 years.⁵ They exhibited outstanding properties such as simple preparation technology, low-cost production, slight curing shrinkage, short production cycle, high-temperature resistance, abrasion resistance and excellent bonding strength.⁶-8 Phosphoric acid

undergoes three ionization steps associated with the three phosphate ions; namely, $H_2PO_4^-$, HPO_4^{2-} and PO_4^{3-} , and they are known as ligands of monodentate, chelating or bridging forms. The strengthening of the binder is due to the chemical bonding of phosphate phases and a change in the stress state. AP binder has been used for various purposes such as coatings, 11,12 adhesives, 13 anti-freeze and paints. However, incompletely cured samples were found to be chemically unstable with respect to rehydration in air. Water molecules were absorbed and formed hydrogen-bonds between two phosphates due to the wet interface layer and weak hygroscopic resistance. Additionally, during the hot water dipping treatment, the moisture could penetrate the glue interface and the bonding between the fiber and the AP interface could be broken, thereby weakening the wet bonding strength.

Many methods have been explored to overcome these problems. Titanium dioxide and alkylsilane were used to modify the AP, with the inorganic adhesive possessing robust, self-healing and superhydrophobic surfaces. Magnesium as a modifier was added to avoid the strength decrease of wood composites under the high humidity condition. AB and BAC as the inorganic fillers were added to the formation of borosilicate glass. CrO3 was added into aluminum phosphate binder, which could achieve excellent rehydration resistance with low thermal conductivity. AlN, NH4F, MgO and ZrO2 were added to AP, lowered the hardening-temperature, and improved rehydration resistance. However, most of these techniques require high-temperature treatment (over 200 °C) and long curing time (1–

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[†] Electronic supplementary information (ESI) available. See DOI: 10.1039/d1ra05552f

5 hours), in some cases, inert atmosphere protection, thus reducing the process feasibility. 18,20 And the use of chromium as a cancer-suspect agent is limited in industrial applications due to potential environmental pollution. These chemical agents are not suitable for wood-based boards. Organic-inorganic hybrids combine the desirable properties of the inorganic phase (thermal stability, and strength) with organic phase (flexibility, processability, and ductility).21 There are varieties of applications, including catalysis,22 adsorption,23 pervaporation,24 sensors,25 and enzyme encapsulation.26 Polyvinyl alcohol (PVA) is the most favorite organic phase material for manufacturing organic-inorganic hybrids.27,28 It has excellent properties such as superior water solubility, good film-forming ability, high strength and biocompatibility.28-31 PVA is non-toxic, noncarcinogenic, showing similar characteristics to bio-adhesives; it is most commonly used in areas such as membranes, 32 adhesives,33 paints, and coatings.31

Bonding wood-based materials using PVA/aluminum phosphate (PAP) organic-inorganic hybrid adhesive has not been reported. The knowledge of PAP would be useful in developing new eco-friendly wood composites. In this study, PVA was chosen as a modifier for aluminum phosphate for preparing the organic-inorganic hybrid adhesive in order to overcome its weak hygroscopic resistance and low wet bonding strengthen. The investigation was carried out on the preparation, bonding mechanism and heat resistant property using X-ray photoelectron spectroscopy (XPS), Fourier transform infrared spectroscopy (FTIR), X-ray diffraction (XRD), Thermogravimetry-Differential Scanning Calorimetry (TG-DSC), nuclear magnetic resonance (NMR) and Scanning Electron Microscope (SEM). Also, the bonding strength was evaluated by measuring the shear strength of fabricated plywood samples.

2. Materials and methods

2.1 Materials

Masson pine veneers and fiber (\sim 10% moisture content, Fujian Furen Wood Industry Co., Ltd, Fuzhou, China) were used to prepare three layers of plywood. Al(OH)₃, H₃PO₄ (concentration of 85%) and ferric oxide (Fe₂O₃) were purchased from Tianjin Zhiyuan Chemical Reagents Factory (Tianjin, China). PVA-1799 (44.5 MW) were bought from Shanghai Aladdin Bio-Chem Technology Co., Ltd. Urea was bought from Shanghai Jiuyi Chemical Reagent Co. Ltd. Tributyl phosphate was received from Sinopharm Chemical Reagent Co. Ltd.

2.2 Methods

2.2.1 Preparation of PAP adhesive and plywood samples. Firstly, the diluted $\rm H_3PO_4$ solution with a concentration of 65% in volume was added into a round-bottom flask (500 mL), then the PVA powder was slowly added into the $\rm H_3PO_4$ solution. Two or three drops of tributyl phosphate are added as a defoaming agent. The mixture was obtained by gently stirring at room temperature to 95 °C, followed by adding urea as a catalyst to facilitate the esterification reaction. After that, the mixture was kept at 95 °C for 150 min. The esterification reaction between

 $\rm H_3PO_4$ and PVA is marked as PP. Secondly, the Al(OH)_3 powder was slowly added into PP solution at 110 °C with rapid stirring for 30 min. After that, the obtained PAP (60% of solid content) adhesive was used for sample preparation. The PAP in this study was synthesized with various PVA/AP mass ratios [m (PVA)/m (AP) of 1.0:100, 1.5:100, 2:100, 2.5:100, 3.0:100, and 3.5:100]. The PVA/APs with the different ratios were referred to as PAP-1.0, PAP-1.5, PAP-2.0, PAP-2.5, PAP-3.0, PAP-3.5, respectively. The PAPs were cooled at room temperature, after which they were mixed with Fe₂O₃ (curing agent, 1.5% of total adhesive weight). The mixtures were used to prepare PAP plywood (PAPW), coating each veneer layer with 200g m $^{-2}$ of the adhesives. The hot-pressing temperature, pressure, and time are 160 °C, 1.0 MPa, and 5 min, respectively. Details are shown in Fig. 1.

2.2.2 Mechanical properties test. The bonding strength of plywood with the size of 100×25 mm ($L \times W$) was tested by a tensile testing machine (MTS, USA) at a constant speed of 10 mm min⁻¹ according to Chinese National Standards GB/T 9846-2015. The reported results were the average of 10 samples. The wet bonding test was performed after samples were soaked in water at 63 °C for 3 hours.

2.2.3 Materials characterization. The rheological behavior of PAP was tested by a rotational rheometer with a PP35Ti parallel plate (HAAKE MARS III, Thermo Electron, USA). The shearing stress in the PAP was tested at 25 °C with the shear rate ranging from 10 s¹ to 1000 s¹. The viscosity was tested at a velocity gradient of 10 s¹, with the temperature ranging from 25 to 190 °C, and a heating rate of 10 °C min⁻¹. The investigation of the reaction mechanisms among Al(OH)3, H3PO4, and wood fibers were carried out by a XPS (ESCALAB 250, USA), NMR (Bruker ADVANCE III 500, Switzerland) spectrometer, and XRD (X'Pert PRO MPD, Philips-FEI, Netherlands). FTIR (Nicolet 5700 FTIR spectrometer, Thermo Fisher Scientific, Waltham, USA) was employed by the KBr pellet method with a range from 4000 to 400 cm⁻¹. XPS experiments were carried out at an ambient temperature in an ultrahigh-vacuum system with Al Kα radiation, the pass energy of 100 eV, the energy step size of 1.00 eV, and the spot size of 500 μm . The ^{31}P and $^{27}A1$ NMR spectra were recorded by 4 mm zirconia oxide rotor with a spinning rate of 10 kHz at room temperature. The typical diffraction pattern and intensity profile of AP, PAP and PAPW were recorded by Co Ka radiation with a 5 mm variable divergence slit (2θ) between 5.0° and 60.0°. The microstructures of samples were analyzed by scanning electron microscopy with an energy-dispersive spectroscopy at an acceleration voltage of 15 kV (SEM-EDS, Phenom ProX, Netherlands). The TG of AP, PAP and PAPW was obtained by a thermogravimetric analyzer (NETZSCH STA 449F3, Germany) with a heating rate of 10 °C min⁻¹ under nitrogen atmosphere, ranging from 20 to 600 °C.

3. Results and discussion

3.1 Rheological and chemical property of PAP

The digital images of AP and PAP are shown in Fig. S1,† and the different proportions of PVA. The adhesives color became darker, which indicates that the degree of esterification between

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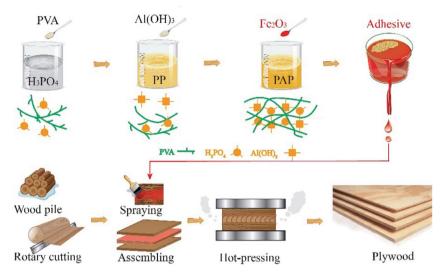


Fig. 1 Preparation process of PAP adhesive and poplar plywood.

PVA and H_3PO_4 was enhanced. In order to investigate the rheological properties of PAPs with different proportions of PVAs, the viscosity and sheering strength were tested, and the results are showed in Fig. 2(a)–(c).

As could be seen in Fig. 2(a), with the increase of velocity gradient (γ), the viscosity (η) of AP, PAP-1% and PAP-2% almost remain constant, with an average value of 24, 50, and 205 mPa s, respectively, which indicates that the η increases as the various proportion of PVA were added. In Fig. 2(b), the shearing stress (τ) increased with the velocity gradient, which means it could be modelled with the equation eqn (1).

$$\tau = \eta \gamma \tag{1}$$

where τ is the shearing stress of adhesive (mPa), η is the viscosity (mPa s), and γ is the velocity gradient (s⁻¹). The viscosity value of AP, PAP-1% and PAP-2% were 20, 50 and 200 m Pa s (Table S1†) which was obtained by linear fitting from Fig. 2(b). The linear fitting value is similar to the average value from Fig. 2(a) and their Adj. R^2 are close to 1, which means the fitting has high precision. The constant value of η indicates that AP, PAP-1% and PAP-2% behaves as a Newtonian fluid, which controls by an important physical parameter of viscosity. However, the viscosity of PAP-3% was not constant when the velocity gradient changed. The η of PAP-3% decreased with the increase of γ . The viscosity curves of PAP-3% were fitted to the power-law model showed in eqn (2).

$$\eta = K\gamma^{n-1} \tag{2}$$

where K is the consistency coefficient (Pa sⁿ), and n is the flow behavior index. The fitted curves of viscosity *versus* velocity gradient are shown in Fig. S2 and S3.† In the case where K equaled 2.02 Pa. sⁿ, n was 0.80. Compared to linear fit, the power-law fit of PAP-3% in shearing stress *versus* velocity gradient had the higher degree of fitting and R^2 reached its maximum value ($R^2 = 1$), which indicates the power-law fit had

a high fitting accuracy (Fig. S2 and Table S2†). Notably, the K and *n* values from power-law fit are in accordance with Fig. S3.† The PAP-3% adhesive can be classified as pseudoplastic fluids because its consistency coefficient (K) is positive, and its flow behavior index (n) is in the range of 0 < n < 1. Under velocity gradient conditions at 10γ s⁻¹ and 25–200 °C, the viscosity of AP and PAP-3 are shown in Fig. 2(c). The peak of AP showed in Fig. 2(c) is the reason why oligomers of aluminophosphates condensed to form orbicular structures and then break to form catenulate structures at this temperature range. 13,34 A sharp peak appeared around 165 °C on the PAP-3% curve in Fig. 2(c). The PVA chains hooked, intertwined, and interlocked each other with the temperature, which increased the viscosity of PAP-3%. When the system temperature continues to go up, the internal energy gradually increases, and the molecular thermal motion becomes active, which expands the molecular spacing, free volume, and decreases viscosity. A similar peak found in PAP-3% could also be seen in AP curve around 180 °C. That was the reason for the interconnection between PVA and AP.

The thermostability of PAP was tested. The TG and DTG curves are presented in Fig. 2(d) and (e). As can be seen in the graphs, AP and PAP samples experience four stages of thermal decomposition. In the first stage, from room temperature (RT) to onset temperature (OT, shown in Table S4†), the mass loss refers to the evaporation of physically adsorbed water in the samples. At the second stage, from OT to 290 °C, the mass loss was resulted from the thermal decomposition of the aluminium dihydrogen phosphate into aluminum oxide, phosphorus pentoxide and water. In the third stage, from 290 to 505 °C, the decomposers in the previous stage reacted to form AlH₃P₃O₁₀ and released the same vapor. In the final stage (i.e. between 505 to 800 °C), the AlH₃P₃O₁₀ decomposed to form Al(PO₃)₃ and AlPO₄ (XRD profile of PAP after 1000 °C calcination is presented in Fig. 5(i)). As shown in Fig. 2(e) and Table S4,† compared to AP, the OT, first peak temperature of thermal decomposition (PT₁), the second peak temperature of thermal decomposition

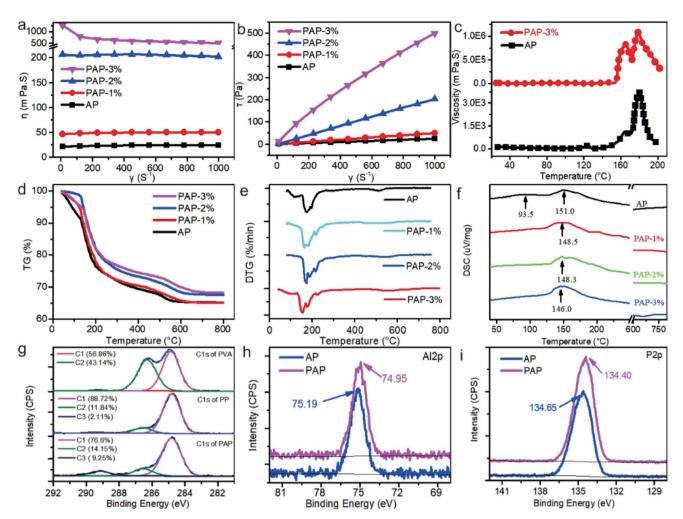


Fig. 2 Rheological and chemical property of AP and PAP: (a) viscosity *versus* velocity gradient; (b) shearing stress *versus* velocity gradient; (c) viscosity *versus* temperature; (d) TG curves; (e) DTG curves; (f) DSC curves; (g) C1s XPS spectrum of PVA, PP and PAP; (h) Al 2p spectrum; and (i) P 2p spectrum.

(PT₂) and the ratio of residual weight (RW) of PAP-1% was lower than AP with 5, 15, 5 °C, and 0.12% respectively. As the proportions of PVA increases, the OT, PT and RW were significantly increased. For example, the OT, PT₁, PT₂, PT₃, and RW of PAP-3% were 8.6 °C, 19 °C, 56 °C and 3.07% respectively. At approximately 150 °C, there was a prominent endothermic peak (EP) of AP and PAP, which resulted in the dehydration condensation process (Fig. 2f). As the proportions of PVA increases, the EP decreased from 151.0 to 146.0 °C, which indicates that the PVA could affect the EP of PAP.

In order to explore the reaction mechanism between PVA and AP, the chemical form of pure PVA, PP, and PAP were examined. As shown in Fig. S4,† there were two elements of C and O in the pure PVA survey curve, and the ratio of C/O was 2.37 instead of 2 in theory. The reason may be due to the dehydroxylation, and the degradation of the polymer under X-ray irradiation changed from C-OH of PVA to C=O, COOH or C-O-C. 35,36 In PP and PAP curves, apart from C and O, new elements of P and Al were discovered. Moreover, there were two peaks in C1s curve of PVA, which presented as C1 (-CH₂-) and

C2 (-CH-OH) of two types carbon atoms in 284.8 and 286.4 eV with the ratio of 56.86 and 43.14%, respectively (Fig. 2g). In contrast, the ratio of C2 in PP dramatically dropped to 11.84%, which indicates that the -OH groups were substantially consumed during esterification. Small peaks found around 289 eV (2.11%) and 292 eV (2.11%) were C=O and COOH, respectively. This results in the degradation of the X-ray irradiation or oxidation of -OH group in an acidic medium. Additionally, in C1s curve of PAP, the ratio of C2 continue to drop to 6.42%, which indicates that some of C-OH groups on the PVA took part in the polymerization reaction with Al(OH)3. The characteristic Al 2p and P 2p peaks of PAP are 74.95 and 134.40 eV, lower than AP with a difference of 0.24 and 0.25 eV, respectively (Fig. 2(h) and (i)). As a result, P-O-C and Al-O-C covalent bonds may form between PVA and AP. 13,37 The reaction process could be described as presented in Fig. 3 Reaction 1. At the same time, C-OH groups of PVA chain could interact with AP through hydrogen bond and crosslink with each other, as shown in Fig. 3 Reaction 2.

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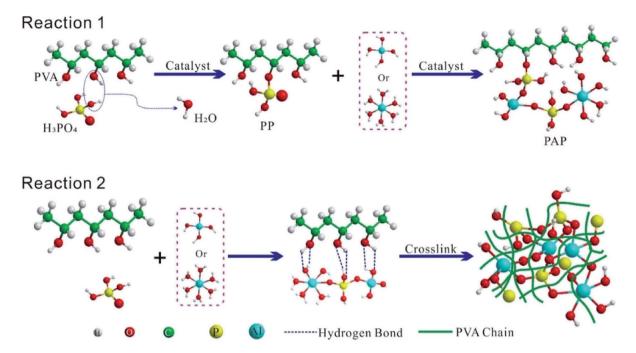


Fig. 3 Reaction mechanism of PVA with AP.

To further investigate the framework of PAP, the ²⁷Al MAS NMR and ³¹P MAS NMR spectra of PAP are presented in Fig. 4. Two peaks at 33.56 and -23.74 ppm could be seen at the ²⁷Al NMR MAS curve (Fig. 4(a)), implying tetracoordinated and octacoordinated Al were present, respectively. The tetracoordinated and octacoordinated Al combined with P atom to form

tetrahedral $Al[OP]_4$ and $Al[OP]_6$ through oxygen bridge, respectively.^{38–40} In Fig. 4(b) only one peak at -24.02 ppm belonged to tetrahedral P species.⁴¹ According to the XRD spectra of PAP, the formation of PAP crystal belonged to $Al(H_2PO_4)$ (JCPDS no. 44-0724, showed in Fig. 4(c)). As a result, the possible structure of PAP is illustrated in Fig. 4(d).

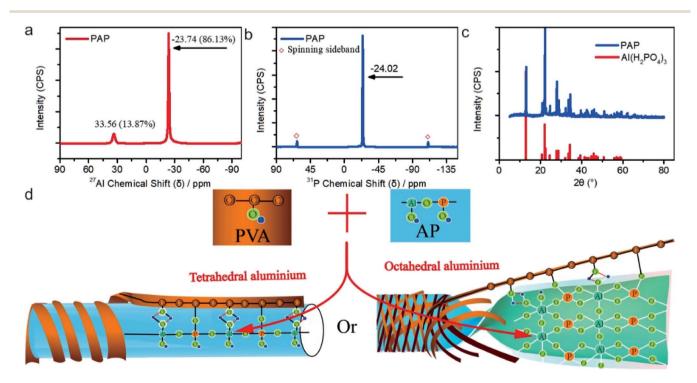


Fig. 4 (a) 27 Al MAS NMR spectra; (b) 31 P MAS NMR spectra; (c) XRD spectra of PAP and Al(H_2PO_4) (JCPDS no. 44-0724) and (d) possible structure of PAP.

3.2 Micromorphology, mechanical property and thermostability of PAP plywood

As shown in Fig. 5(a), the surface of wood fiber without adhesive exhibited a distinct smooth surface. The appearance of lines and wrinkles surface and densified structure could be seen in the PAP film since the polymerization process was under heat (Fig. 5(b)). This structure could help to improve the mechanical strength and water resistance property. A thin film and some adhesive bundles are closely packed on the surface of the wood fiber (Fig. 5(c)). The tensile test schematic diagram is shown in Fig. 5(d). The plywood's dry bonding strength and tensile curves are also shown in Fig. 5(e) and S5b.† IB of samples gradually increased as different proportions of PVAs were used (Fig. 5(e)). Compared to AP sample (1.98 MPa), the PAP-3% increased to 2.28 MPa with a 15.2% increment. There was a substantial difference between the wet bonding strength of AP and PAP samples (Fig. 5(f) and S5a†). The wet bonding strength of AP sample was as low as 0.1 MPa, which could easily be broken by hand. There were plenty of -O- structures with high electronegativity in the cured phosphate adhesive, which could connect to H molecule of moisture to form -OH groups,

resulted in some nodes failure of 3D net structure. 17,42 As a result, in wet bonding strength tests or samples in high humidity, the bonding strength could decrease dramatically. The wet bonding strength of the PAP-0.5 sample greatly increased to 0.36 MPa, 3.6 times that of the AP sample. Moreover, the bonding strength of the PAP-3.0 sample reached as high as 0.79 MPa, which increased by 690% compared to the AP sample. After assessing the bond interface of the tested samples, the interface showed there was an adhesive failure in AP samples. In contrast, PAP-3.0 samples revealed tearing and destruction on the bond interfaces between different layers of the wood veneer, which indicates a highly cohesive force between PAP adhesive and veneers (Fig. 5(f)). PVA took part in the polycondensations reaction with AP. The -OH groups of PVA and AP dehydrated to form hydrophobic nodes and decreased the chance of creating hydrated molecules with moisture. 43 This could be verified by the contact angle tests of AP and PAP (Fig. S6†). The organic and inorganic hydration could reduce the brittleness of cured AP adhesive and increase the filmforming property. Meanwhile, they lessen the -OH groups inside the cured adhesive and create a barrier composed of

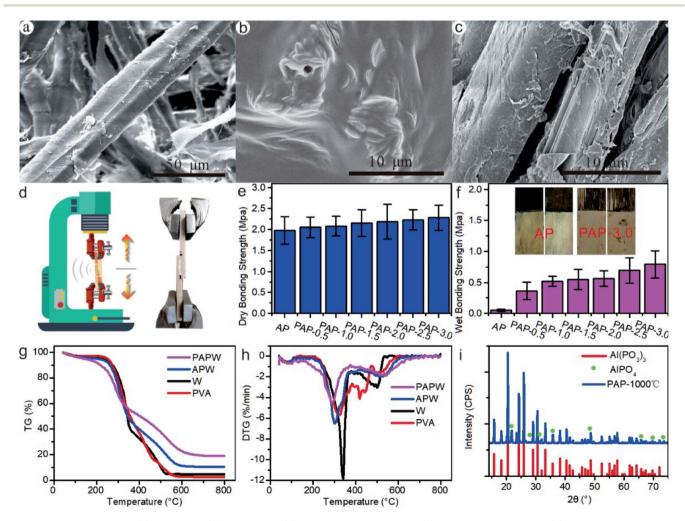


Fig. 5 Micromorphology of (a) wood fiber, (b) PAP film and (c) PAP plywood; tensile test: (d) test schematic diagram, (e) dry bonding strength and (f) wet bonding strength; thermostability: (g) TG curves, (h) DTG curves and (i) XRD profile of PAP after 1000 °C calcinations.

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organic C-C long chain to keep moisture away from breaking the P-O bond and increase the wet bonding strength.⁴²

In order to investigate the thermostability of PAPW; TG, DTG and DSC were tested, and results showed in Fig. 5(g) and (h). As can be seen in Fig. 5(g) and (h), the thermostability of wood fiber (W) experienced three stages of degradation. At the first stage (below 110 °C), the mass loss resulted from the evaporation of free water in the wood fiber, which was 3.72%. In the second stage (110–380 $^{\circ}\text{C}),$ there was a mass loss of 58.30% because of the decomposed hemicellulose and lignin. At the last stage (380-800 °C), the mass loss was 30.62% due to the deteriorated cellulose. The onset and second peak temperature of thermal decomposition (PT₂) of PAPW increased by 19.9 °C and 25.4 °C, respectively (Table S5†). The RW of PAPW was 18.89, which increased by 8.37% and 14.04% for APW and W, respectively. Aluminum orthophosphate (AlPO₄) and aluminum metaphosphate (Al(PO₃)₃) were formed when heating (Fig. 5(i)), which could improve the thermostability and fire resistance. 44,45 Therefore, the introduction of PVA into PAPW could bring forward decomposition and shorten the time to PT, which promoted the char forming in the surface of the sample, reducing the production of organic volatiles and prevented heat from transferring into inner area. Increasing PT2 implied that it needs a higher temperature for thermo-decomposition and for the char layer's thermostability to improve. As a result, the PAP promoted the catalytic charring effect and decreased the organic volatiles production, resulting in increased thermostability.

In order to investigate the combination between PAP and wood, the XPS and XRD test was performed, and the results are showed in Fig. 6.

As shown in Fig. 6(a), new elements of Al and P were found in PAPW sample, which signifies that the PAP was coated on the wood surface. The C2 (C-OH groups) percentage dramatically decreased from 43.1% wood to 24.4% PAPW (Fig. 6(b)). The same scenario was observed in C3 and C4 of PAPW with 1.8 and 0.3% reduction, respectively, compared to wood. There was no big difference in the XRD profile between wood and PAPW (Fig. 6(c)). The reason may be that there is a much smaller amount of PAP in the sample compared to wood fiber. The hydroxyl group consumption indicates that the PAP might connect to the wood surfaces with hydrogen bonds or even covalent bonds. The combination mechanism between PAP and wood is shown in Fig. 6(d). The adhesive crosslinked PVA with AP coated on the surface of wood veneer, which could closely combine with wood fiber and kept moisture from interacting with the bond interface.

4. Conclusion

In summary, PVA modified aluminum phosphate adhesive with non-formaldehyde, ecologically benign, and high cohesiveness was fabricated. Covalent bonds were formed between PVA and aluminum phosphate, enhancing the base adhesive and inhibiting moisture penetration. The dry and wet bonding strength increased to 2.28 and 0.79 MPa with a 15.2 and 690% increment, respectively. The thermostability of PAP and plywood sample were improved. Therefore, it could be concluded that this finding brings about high-performance of PAP adhesive and exhibit prospects for the preparation of non-formaldehyde wood-based panels.

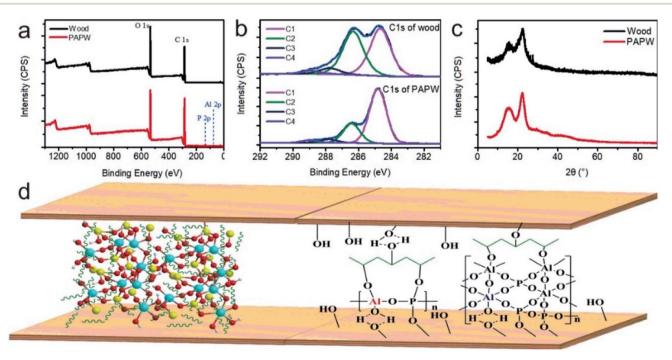


Fig. 6 XPS curves: (a) survey and (b) C1s of wood and PAPW; (c) XRD profile of wood and PAPW; (d) combination mechanism between PAP and wood.

Conflicts of interest

The authors declare no competing financial interest.

Acknowledgements

This work is financed by the Scientific Research Foundation of Wuyi University (YJ201913), Fujian Educational and Scientific Research Projects for Young and Middle-aged Teachers (JAT190785), Fujian Natural Science Foundation (Youth Innovation) (2020J05219), Undergraduate Innovation and Entrepreneurship Training Plan of Wuyi University (S202010397036) and Innovative Utilization of Characteristic Biomass Resources in Northern Fujian Province (2020-SSTD-09).

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